



8.0A SCHOTTKY BARRIER RECTIFIERS -40V- 200V SMC-T3 PACKAGE

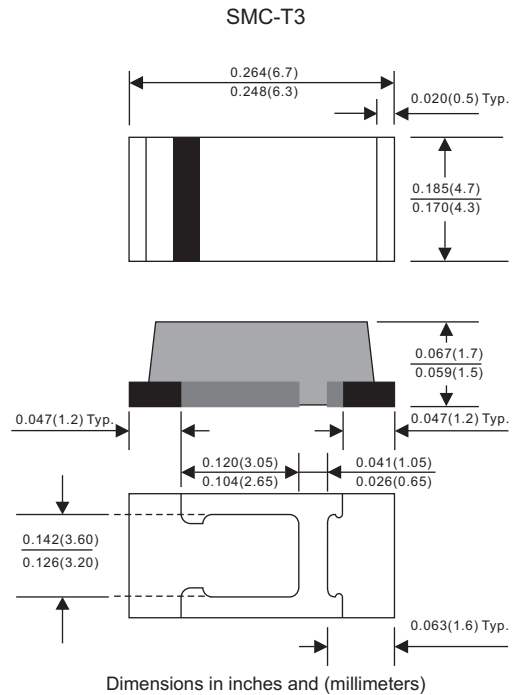
Features

- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guardring for overvoltage protection.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228
- **Moisture Sensitivity Level 1**

Mechanical data

- Epoxy: UL94-V0 rated flame retardant
- Case : Molded plastic, SMC-TH
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any
- Weight : Approximated 0.1443 gram

Package outline



Maximum ratings and Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I_o			8.0	A
Forward surge current	8.3ms single half sine-wave superimposed on rate load (JEDEC methode)	I_{FSM}			150	A
Reverse current	$V_R = V_{RRM} \quad T_J = 25^{\circ}\text{C}$	I_R			0.5	mA
	$V_R = V_{RRM} \quad T_J = 100^{\circ}\text{C}$				50	
Diode junction capacitance	$f=1\text{MHz}$ and applied 4V DC reverse voltage	C_J		700		pF
Storage temperature		T_{STG}	-55		+150	$^{\circ}\text{C}$

SYMBOLS	V_{RRM}^{*1} (V)	V_{RMS}^{*2} (V)	V_R^{*3} (V)	V_F^{*4} (V)	Operating temperature $T_J, (^{\circ}\text{C})$
FM840-T3	40	28	40	0.55	-55 to +125
FM860-T3	60	42	60	0.70	
FM8100-T3	100	70	100	0.85	
FM8150-T3	150	105	150	0.90	
FM8200-T3	200	140	200	0.92	

*1 Repetitive peak reverse voltage

*2 RMS voltage

*3 Continuous reverse voltage

*4 Maximum forward voltage@ $I_F=8.0\text{A}$

Rating and characteristic curves

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

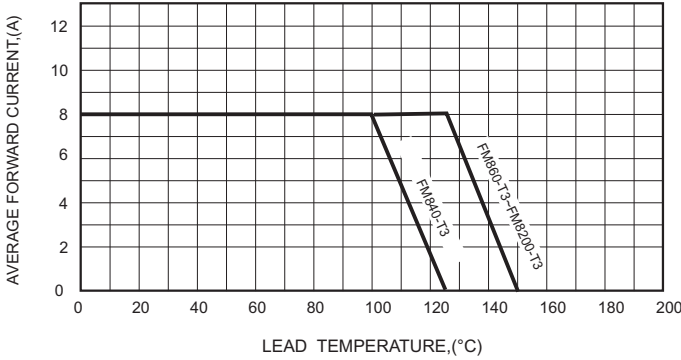


FIG.2-TYPICAL FORWARD CHARACTERISTICS

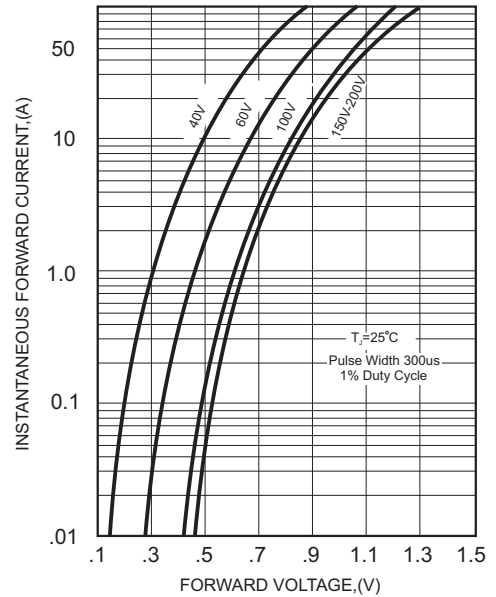


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

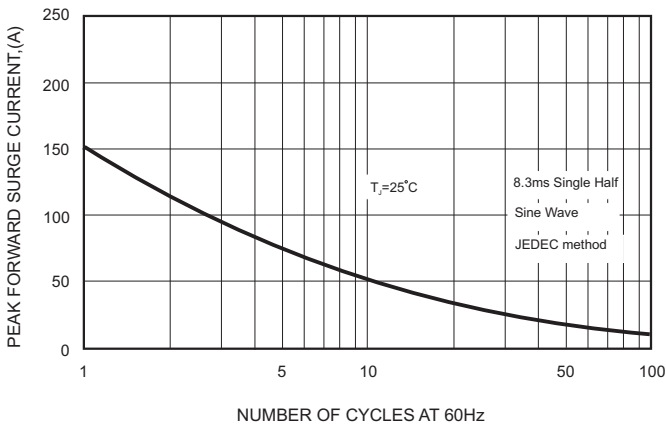


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

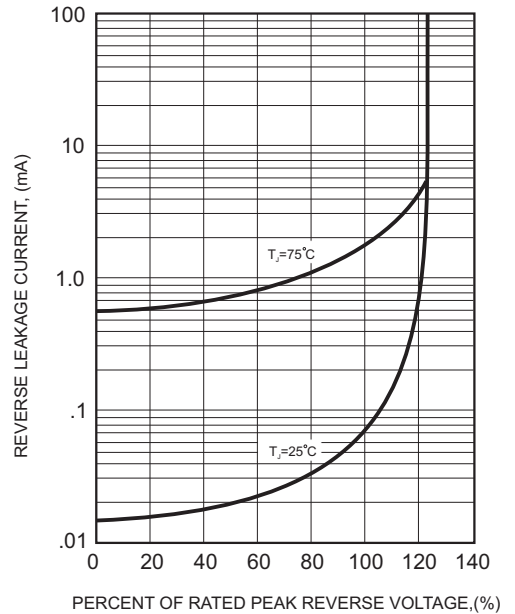
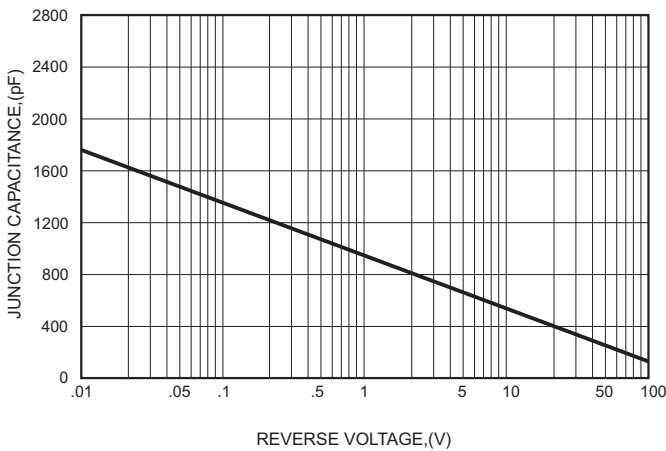


FIG.4-TYPICAL JUNCTION CAPACITANCE





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FM840-T3 THRU FM8200-T3

Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA. (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMC-T3	13"	3,000	8.0	6,000	337*337*37	330	350*330*360	48,000	17.2

Marking

Type number	Marking code
FM840-T3-TH	SS84
FM860-T3-TH	SS86
FM8100-T3-TH	S810
FM8150-T3-TH	S815
FM8200-T3-TH	S820

Note: T3: Package code, SMC-T3

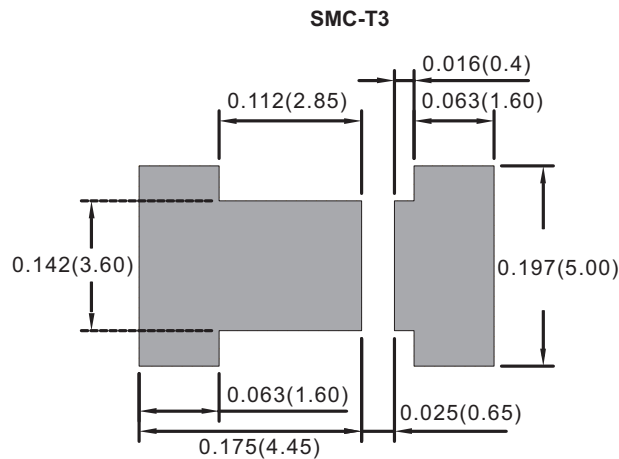
-T: Taping Reel

Pb-Free package is available

RoHS product for packing code suffix "G"

Halogen free product for packing code suffix "H"

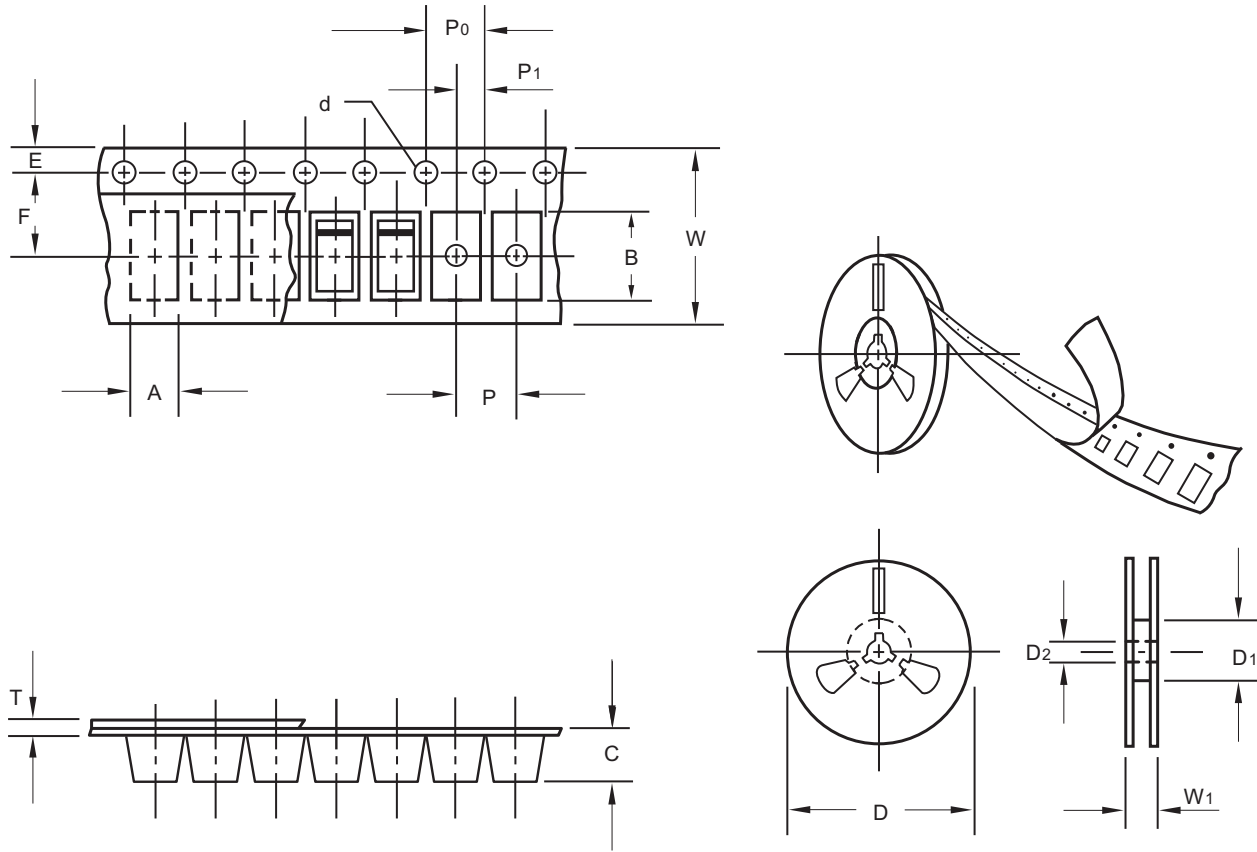
Suggested solder pad layout



Dimensions in inches and (millimeters)



Packing information



unit:mm

Item	Symbol	Tolerance	SMC-T3
Carrier width	A	0.1	4.85
Carrier length	B	0.1	6.95
Carrier depth	C	0.1	1.85
Sprocket hole	d	0.1	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D1	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	62.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	P	0.1	8.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.23
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.00

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.



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SMC-T3 PACKAGE

FM840-T3
THRU
FM8200-T3

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